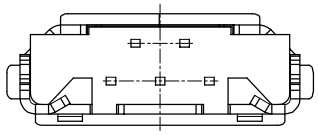
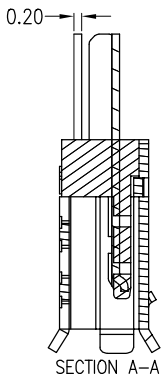
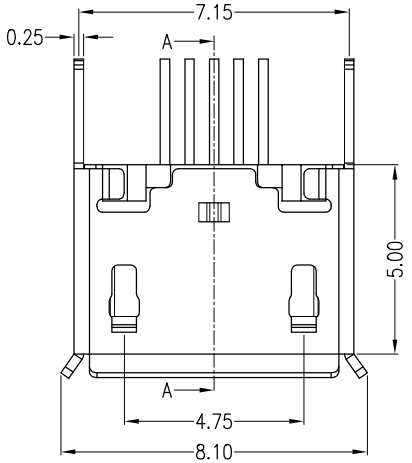
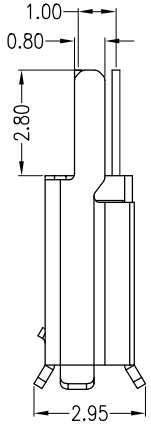
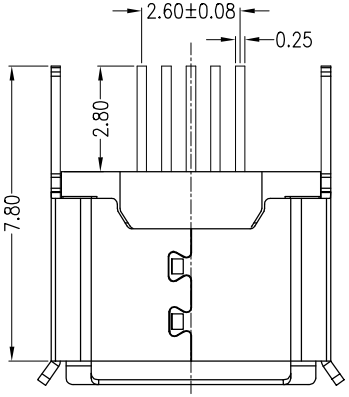
REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE

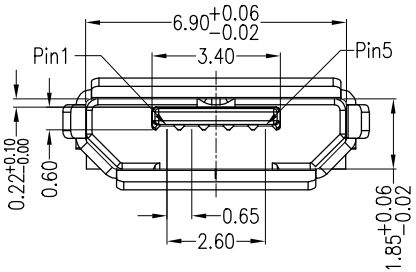


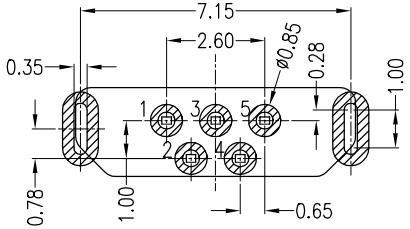












RECOMMANDED PCB LAYOUT

PCB图仅供参考

Note:
1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: SUS304,t=0.25mm

2.Specification:
- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

A 01 S B X X X X X XX-671

① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

- ⑤ 外壳材质: 7:SUS304R-1/2H
- ⑥ 外壳电镀: 1:N50u'' / 2:雾T50u'' / 3:N+Au1u'' (脚) / 4:Au1u''
- ⑦ 端子材质: 4:C5191R-EH
- ⑧ 主体材质: 1:LCP
- ⑨ 主体颜色: B:黑色
- ⑩ 端子电镀: 01:Au1u'';02:Au1.5u'';03:Au3u'';05:Au5u'';10:Au10u'';15:Au15u'';30:Au30u''

PART NO: A01SBXXXXXXX-671		MATERAL: SEE NOTE	深圳扬讯电子有限公司
MODEL NO: XX		FINSH: SEE NOTE	
UNIT: MM	SIZE: A4	COLOR: SEE NOTE	TITLE: Micro usb 5s B型180度插板脚长2.8
TOLERANCE UNSPECIFIED .x 0.15 .xx 0.10 .xxx 0.05 Ang. 1°		DR: xiayouhong	DWG NO: A671 REV: A
		CHK:	
		APP:	SCALE: 5:1 DATE: 2016.06.18